

Result of tenders of RMB Sovereign Bonds held on July 5, 2018

The following is issued on behalf of the Hong Kong Monetary Authority:

Result of tenders of RMB Sovereign Bonds held on July 5, 2018:

Tender result

Tender Date : July 5, 2018

Bonds available for Tender : 2-year RMB Bonds

Issue Number : BCMKFB18016

Issue Date : July 9, 2018

Maturity Date : July 9, 2020 (or the closest coupon payment date)

Application Amount : RMB 8,492 million

Issue Amount : RMB 3,000 million

Average accepted Coupon Rate : 3.47%

Highest accepted Coupon Rate (Bonds' Coupon) : 3.65%

Lowest accepted Coupon Rate : 3.00%

Allocation Ratio : Approximately 36.65%

Tender result

Tender Date : July 5, 2018

Bonds available for Tender : 5-year RMB Bonds

Issue Number : BCMKFB18017

Issue Date : July 9, 2018

Maturity Date : July 9, 2023 (or the closest coupon payment date)

Application Amount : RMB 4,043.5 million

Issue Amount : RMB 1,500 million

Average accepted Coupon Rate : 3.62%

Highest accepted Coupon Rate (Bonds' Coupon) : 3.80%

Lowest accepted Coupon Rate : 3.00%

Allocation Ratio : Approximately 44.10%